Preliminary Specification, V 1.1, October 2004

# TDA 5220 ASK/FSK Single Conversion Receiver Version 1.1

Wireless Control Components



Never stop thinking.

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#### TDA 5220

| Revision History:<br>Previous Version: |          | 2004-10-20                          | V 1.1 |
|--|----------|-------------------------------------|-------|
|  |          | none                                |       |
| Page                                   | Subjects | (major changes since last revision) |       |
|  |          |                                     |       |
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#### **Product Description**

## 1 **Product Description**

## 1.1 Overview

The IC is a very low power consumption single chip FSK/ASK Superheterodyne Receiver (SHR) for the frequency bands 810 to 870 MHz and 400 to 440 MHz. The IC offers a high level of integration and needs only a few external components. The device contains a low noise amplifier (LNA), a double balanced mixer, a fully integrated VCO, a PLL synthesiser, a crystal oscillator, a limiter with RSSI generator, a PLL FSK demodulator, a data filter, an advanced data comparator (slicer) with selection between two threshold modes and a peak detector. Additionally there is a power down feature to save current and extend battery life, and two selectable alternatives of generating the data slicer threshold.

## 1.2 Features

- Low supply current (Is = 5.7/5.9 mA typ. in FSK mode, Is = 5.0/5.2 mA typ. in ASK mode for 434/868 MHz)
- Supply voltage range 5V ±10%
- Power down mode with very low supply current (50nA typ.)
- FSK and ASK demodulation capability
- Fully integrated VCO and PLL Synthesiser
- ASK sensitivity better than -106 dBm over specified temperature range (- 40 to +105°C)
- FSK sensitivity better than -100 dBm over specified temperature range (- 40 to +105°C)
- Selectable frequency ranges 810-870 MHz and 400-440 MHz
- Limiter with RSSI generation, operating at 10.7MHz
- 2nd order low pass data filter with external capacitors
- Data slicer with selection between two threshold modes (see Section 2.4.8)

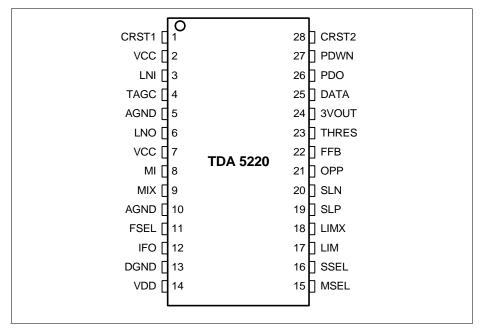
## 1.3 Application

- Keyless Entry Systems
- Remote Control Systems
- Alarm Systems
- Low Bitrate Communication Systems



## 2 Functional Description

## 2.1 Pin Configuration

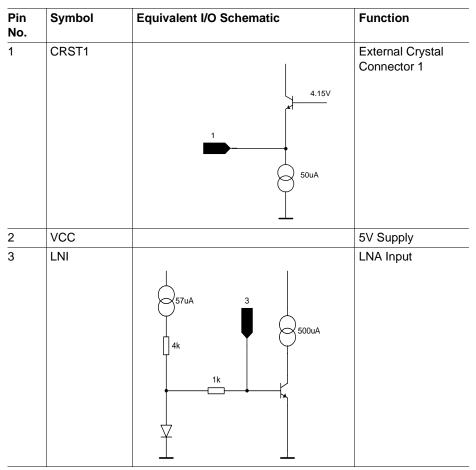


## Figure 1 Pin Configuration



## 2.2 Pin Definition and Functions

#### Table 1 Pin Definition and Function



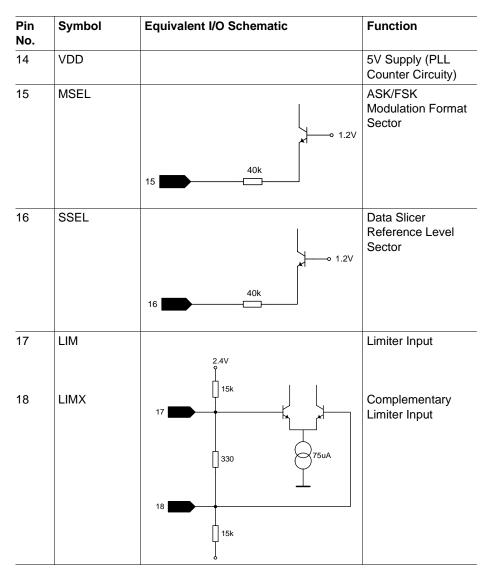


| Pin<br>No. | Symbol | Equivalent I/O Schematic                             | Function                     |
|------------|--------|--|------------------------------|
| 4          | TAGC   | 4.3V<br>4.3V<br>4.3V<br>3uA<br>4.1k<br>1.4uA<br>1.7V | AGC Time Constant<br>Control |
| 5          | AGND   |  | Analogue Ground<br>Return    |
| 6          | LNO    | 5V<br>1k<br>6  | LNA Output                   |
| 7          | VCC    |  | 5V Supply                    |

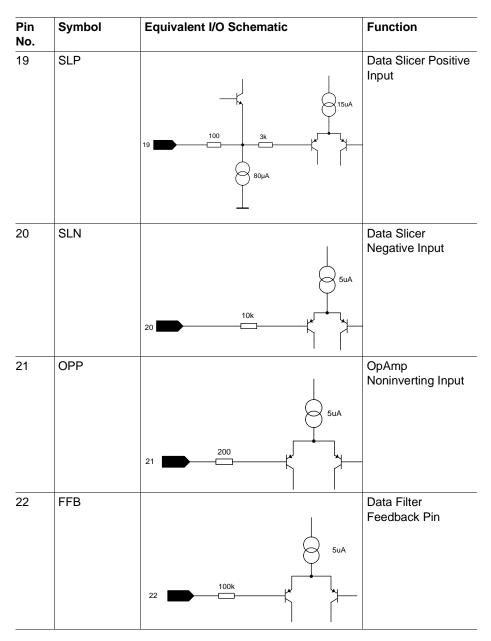


| Pin<br>No. | Symbol | Equivalent I/O Schematic     | Function                                       |
|------------|--------|------------------------------|--|
| 8          | MI     | 1.7V                         | Mixer Input                                    |
| 9          | MIX    | 8 <b>1 1 1 1 1 1 1 1 1 1</b> | Complementary<br>Mixer Input                   |
| 10         | AGND   |                              | Analogue Ground<br>Return                      |
| 11         | FSEL   | 1.2V • 750<br>2k             | 868/434 MHz<br>Operating<br>Frequency Selector |
| 12         | IFO    | 12 60 2.2V                   | 10.7 MHz IF Mixer<br>Output                    |
| 13         | DGND   |                              | Digital Ground<br>Return                       |

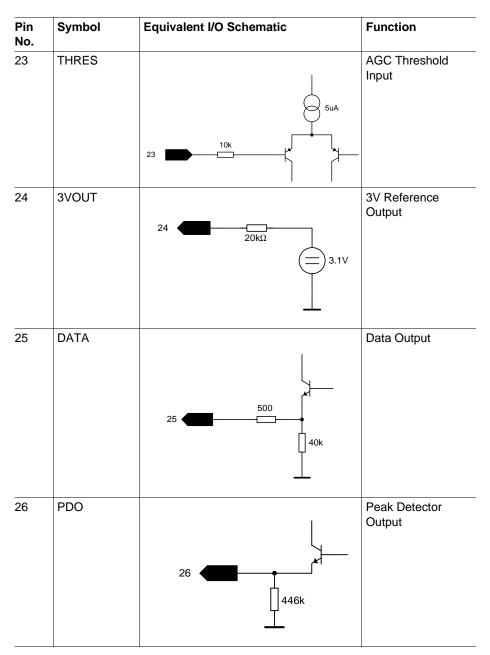














| Pin<br>No. | Symbol | Equivalent I/O Schematic | Function                        |
|------------|--------|--------------------------|---------------------------------|
| 27         | PDWN   | 27                       | Power Down Input                |
| 28         | CRST2  | 28 4.15                  | External Crystal<br>Connector 2 |



## 2.3 Functional Block Diagram

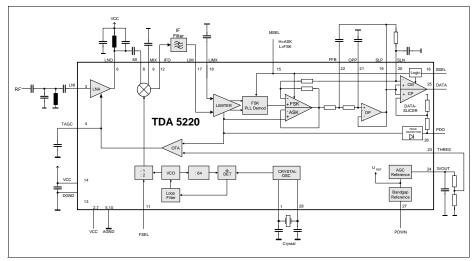


Figure 2 Block Diagram

## 2.4 Functional Block Description

## 2.4.1 Low Noise Amplifier (LNA)

The LNA is an on-chip cascode amplifier with a voltage gain of 15 to 20dB. The gain figure is determined by the external matching networks situated ahead of LNA and between the LNA output LNO (Pin 6) and the Mixer Inputs MI and MIX (Pins 8 and 9). The noise figure of the LNA is approximately 3dB, the current consumption is 500µA. The gain can be reduced by approximately 18dB. The switching point of this AGC action can be determined externally by applying a threshold voltage at the **THRES** pin (Pin 23). This voltage is compared internally with the received signal (RSSI) level generated by the limiter circuitry. In case that the RSSI level is higher than the threshold voltage the LNA gain is reduced and vice versa. The threshold voltage can be generated by attaching a voltage divider between the **3VOUT** pin (Pin 24) which provides a temperature stable 3V output generated from the internal bandgap voltage and the **THRES** pin as described in Section 3.1. The time constant of the AGC action can be determined by connecting a capacitor to the TAGC pin (Pin 4) and should be chosen along with the appropriate threshold voltage according to the intended operating case and interference scenario to be expected during operation. The optimum choice of AGC time constant and the threshold voltage is described in Section 3.1.



## 2.4.2 Mixer

The Double Balanced Mixer downconverts the input frequency (RF) in the range of 400-440MHz/810-870MHz to the intermediate frequency (IF) at 10.7MHz with a vol-tage gain of approximately 21dB by utilising either high- or low-side injection of the local oscillator signal. In case the mixer is interfaced only single-ended, the unused mixer input has to be tied to ground via a capacitor. The mixer is followed by a low pass filter with a corner frequency of 20MHz in order to suppress RF signals to appear at the IF output (**IFO** pin). The IF output is internally consisting of an emitter follower that has a source impedance of approximately  $330\Omega$  to facilitate interfacing the pin directly to a standard 10.7MHz ceramic filter without additional matching circuitry.

## 2.4.3 PLL Synthesizer

The Phase Locked Loop synthesizer consists of a VCO, an asynchronous divider chain, a phase detector with charge pump and a loop filter and is fully implemented on-chip. The VCO is including spiral inductors and varactor diodes. The tuning range of the VCO guarantee over production spread and the specified temperature range is 820 and 860MHz. The oscillator signal is fed both to the synthesiser divider chain and to the downconverting mixer. In case of operation in the 400 to 440MHz range the signal is divided by two before it is fed to the Mixer. Depending on whether high- or low-side injection of the local oscillator is used, the receiving frequency ranges are 810 to 840MHz and 840 to 870MHz or 400 to 420MHz and 420 to 440MHz - see also Section 3.4. To be able to switch between two different frequency channels a divider ratio of either 32 or 32.25 can be selected via the FSEL-Pin.

| Table 2 | FSEL-Pin Operating States |
|---------|---------------------------|
|---------|---------------------------|

| FSEL | RF         |
|------|------------|
| Open | 400-440MHz |
| GND  | 810-870MHz |

## 2.4.4 Crystal Oscillator

The calculation of the value of the necessary crystal load capacitance is shown in Section 3.3, the crystal frequency calculation is explained in Section 3.4.

## 2.4.5 Limiter

The Limiter is an AC coupled multistage amplifier with a cumulative gain of approximately 80 dB that has a bandpass-characteristic centred around 10.7 MHz. It has a typical input impedance of 330  $\Omega$  to allow for easy interfacing to a 10.7 MHz ceramic IF filter. The limiter circuit also acts as a Receive Signal Strength Indicator (RSSI) generator which produces a DC voltage that is directly proportional to the input



signal level as can be seen in Figure 4. This signal is used to demodulate ASKmodulated receive signals in the subsequent baseband circuitry. The RSSI output is applied to the modulation format switch, to the Peak Detector input and to the AGC circuitry.

In order to demodulate ASK signals the MSEL pin has to be in its 'High'-state as described in the next chapter.

## 2.4.6 FSK Demodulator

To demodulate frequency shift keyed (FSK) signals a PLL circuit is used that is contained fully on chip. The Limiter output differential signal is fed to the linear phase detector as is the output of the 10.7 MHz center frequency VCO. The demodulator gain is typically 200µV/kHz. The passive loop filter output that is comprised fully on chip is fed to both the VCO and the modulation format switch described in more detail below. This signal is representing the demodulated signal with low frequencies applied to the demodulator demodulated to logic zero and high frequencies demodulated to logic ones. However this is only valid in case the local oscillator is low-side injected to the mixer which is applicable to receive frequencies above 840 or 420MHz. In case of receive frequencies below 840 or 420MHz high frequencies are demodulated as logical zeroes due to a sign inversion in the downconversion mixing process as the L0 is high-side injected to the mixer. See also Section 3.4.

The modulation format switch is actually a switchable amplifier with an AC gain of 11 that is controlled by the **MSEL** pin (Pin 15) as shown in the following table. This gain was chosen to facilitate detection in the subsequent circuits. The DC gain is 1 in order not to saturate the subsequent Data Filter with the DC offset produced by the demodulator in case of large frequency offsets of the IF signal. The resulting frequency characteristic and details on the principle of operation of the switch are described in Section 3.6.

#### Table 3 MSEL Pin Operating States

| MSEL              | Modulation Format |
|-------------------|-------------------|
| Open              | ASK               |
| Shorted to ground | FSK               |

The demodulator circuit is switched off in case of reception of ASK signals.

## 2.4.7 Data Filter

The data filter comprises an OP-Amp with a bandwidth of 100kHz used as a voltage follower and two  $100k\Omega$  on-chip resistors. Along with two external capacitors a 2nd order



Sallen-Key low pass filter is formed. The selection of the capacitor values is described in Section 3.2.

## 2.4.8 Data Slicer

The data slicer is a fast comparator with a bandwidth of 100 kHz. This allows for a maximum receive data rate of up to 100kBaud. The maximum achievable data rate also depends on the IF Filter bandwidth and the local oscillator tolerance values. Both inputs are accessible. The output delivers a digital data signal (CMOS-like levels) for subsequent circuits. A self-adjusting slicer-threshold on pin 20 its generated by a RC-term. In ASK-mode alternatively a scaled value of the voltage at the PDO-output (approx. 87%) can be used as the slicer-threshold as shown in Table 4. The data slicer threshold generation alternatives are described in more detail in Section 3.5.

| SSEL | MSEL | Selected Slicing Level (SL)           |
|------|------|---------------------------------------|
| x    | Low  | external SL on Pin 20 (RC-term, e.g.) |
| High | High | external SL on Pin 20 (RC-term, e.g.) |
| Low  | High | 87% of PDO-output (approx.)           |

#### Table 4 SSEL Pin Operating States

## 2.4.9 Peak Detector

The peak detector generates a DC voltage which is proportional to the peak value of the receive data signal. A capacitor is necessary. The input is connected to the output of the RSSI-output of the Limiter, the output is connected to the **PDO** pin (Pin 26). This output can be used as an indicator for the received signal strength to use in wake-up circuits and as a reference for the data slicer in ASK mode. Note that the RSSI level is also output in case of FSK mode.

## 2.4.10 Bandgap Reference Circuitry

A Bandgap Reference Circuit provides a temperature stable reference voltage for the device. A power down mode is available to switch off all subcircuits which is controlled by the PWDN pin (Pin 27) as shown in the following table. The supply current drawn in this case is typically 50nA.

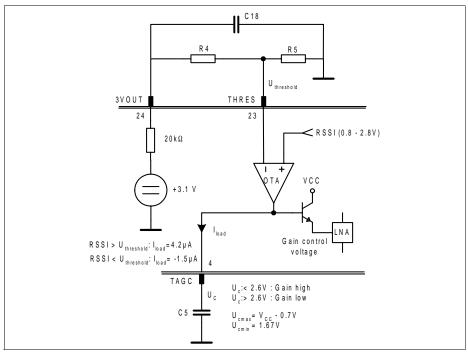
#### Table 5 PDWN Pin Operating States

| PDWN                   | Operating State |
|------------------------|-----------------|
| Open or tied to ground | Powerdown Mode  |
| Tied to Vs             | Receiver On     |



# 3 Applications

## 3.1 Application Circuit



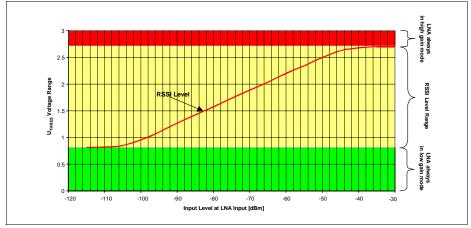
## Figure 3 LNA Automatic Gain Control Circuity

The LNA automatic gain control circuitry consists of an operational transimpedance amplifier that is used to compare the received signal strength signal (RSSI) generated by the Limiter with an externally provided threshold voltage  $U_{thres}$ . As shown in the following figure the threshold voltage can have any value between approximately 0.8 and 2.8V to provide a switching point within the receive signal dynamic range.

This voltage  $U_{thres}$  is applied to the **THRES** pin (Pin 23) The threshold voltage can be generated by attaching a voltage divider between the **3VOUT** pin

(Pin 24) which provides a temperature stable 3V output generated from the internal bandgap voltage and the **THRES** pin. If the RSSI level generated by the Limiter is higher than  $U_{thres}$ , the OTA generates a positive current  $I_{load}$ . This yields a voltage rise on the **TAGC** pin (Pin 4). Otherwise, the OTA generates a negative current. These currents do not have the same values in order to achieve a fast-attack and slow-release action of the





AGC and are used to charge an external capacitor which finally generates the LNA gain control voltage.

## Figure 4 RSSI Level and Permissive AGC Threshold Levels

The switching point should be chosen according to the intended operating scenario. The determination of the optimum point is described in the accompanying Application Note, a threshold voltage level of 1.8V is apparently a viable choice. It should be noted that the output of the **3VOUT** pin is capable of driving up to 50µA, but that the **THRES** pin input current is only in the region of 40nA. As the current drawn out of the **3VOUT** pin is directly related to the receiver power consumption, the power divider resistors should have high impedance values. The sum of R1 and R2 has to be 600k $\Omega$  in order to yield 3V at the **3VOUT** pin. R1 can thus be chosen as 240k $\Omega$ , R2 as 360k $\Omega$  to yield an overall **3VOUT** output current of 5µA<sup>1</sup> and a threshold voltage of 1.8V

**Note:** If the LNA gain shall be kept in either high or low gain mode this has to be accomplished by tying the **THRES** pin to a fixed voltage. In order to achieve high gain mode operation, a voltage higher than 2.8V shall be applied to the **THRES** pin, such as a short to the **3VOLT** pin. In order to achieve low gain mode operation **THRES** has to be connected to GND.

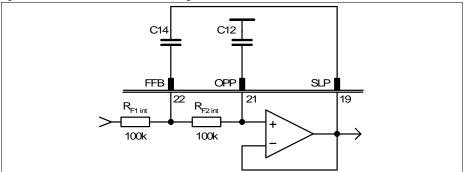
As stated above the capacitor connected to the **TAGC** pin is generating the gain control voltage of the LNA due to the charging and discharging currents of the OTA and thus is also responsible for the AGC time constant. As the charging and discharging currents are not equal two different time constants will result. The time constant corresponding to the charging process of the capacitor shall be chosen according to the data rate. According to measurements performed at Infineon the capacitor value should be greater than 47nF.

<sup>1)</sup> note the 20k  $\!\Omega$  resistor in series with the 3.1V internal voltage source



## 3.2 Data Filter Design

Utilising the on-board voltage follower and the two  $100k\Omega$  on-chip resistors a 2nd order Sallen-Key low pass data filter can be constructed by adding 2 external capacitors between pins 19 (SLP) and 22 (FFB) and to pin 21 (OPP) as depicted in the following figure and described in the following formulas<sup>1</sup>.



#### Figure 5 Data Filter Design

with R<sub>F1int</sub>=R<sub>F2int</sub>=R

$$C14 = \frac{2Q\sqrt{b}}{R2\pi f_{3dB}} \quad C12 = \frac{\sqrt{b}}{4QR\pi f_{3dB}}$$

with

$$Q = \frac{\sqrt{b}}{a}$$

Q is the qualify factor of the poles where, in case of a Bessel filter a=1.3617, b=0.618 and thus Q=0.577

and in case of a Butter worth filter a=1.414, b=1 and thus Q=0.71

Example: Butter worth filter with  $f_{3dB}$ =5kHz and R=100k $\Omega$ : C14=450pF, C12=225pF

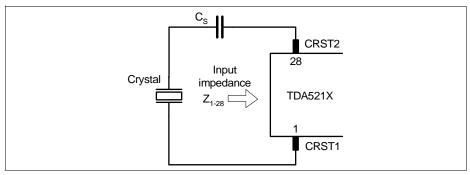
Preliminary Specification

<sup>1)</sup> taken from Tietze/Schenk: Halbleiterschaltungstechnik, Springer Berlin, 1999



## 3.3 Crystal Load Capacitance Calculation

The value of the capacitor necessary to achieve that the crystal oscillator is operating at the intended frequency is determined by the reactive part of the negative resistance of the oscillator circuit as shown in Section 4.1.3 and by the crystal specifications given by the crystal manufacturer.



#### Figure 6 Determination of Series Capacitance Vale for the Quartz Oscillator

The required series capacitor for a crystal with specified load capacitance  $\ensuremath{C_L}$  can be calculated as

$$C_S = \frac{1}{\frac{1}{C_L} + 2\pi f X_L}$$

C<sub>L</sub> is the nominal load capacitance specified by the crystal manufacturer.

Example:

13.4 MHz:  $C_L = 12 \text{ pF}$   $X_L = 1010 \Omega$   $C_S = 5.9 \text{ pF}$ 

This value may be obtained by putting two capacitors in series to the crystal, such as 22pF and 8.2pF for 13.4MHz.

But please note that the calculated C<sub>S</sub>-value includes all parasitic.

## 3.4 Crystal Frequency Calculation

As described in Section 2.4.3 the operating range of the on-chip VCO is wide enough to guarantee a receive frequency range between 810 and 870MHz or between 400 and 440MHz. The VCO signal is divided by 2 before applied to the mixer in case of operation at 434MHz. This local oscillator signal can be used to downconvert the RF signals both



with high- or low-side injection at the mixer. High-side injection of the local oscillator has to be used for receive frequencies between 810 and 840MHz or between 400 and 420MHz. In this case the local oscillator frequency is calculated by adding the IF frequency (10.7 MHz) to the RF frequency. Thus the higher frequency of a FSK-modulated signal is demodulated as a logical zero (low).

Low-side injection has to be used for receive frequencies above 840 MHz or above 420 MHz. The local oscillator frequency is calculated by subtracting the IF frequency (10.7 MHz) from the RF frequency then. In this case no sign-inversion occurs and the higher frequency of a FSK-modulated signal is demodulated as a logical one (high). The overall division ratios in the PLL are 32 or 64 depending on whether the FSEL-pin is left open or tied to ground.

Therefore the crystal frequency may be calculated by using the following formula:

$$f_{QU} = \frac{f_{RF} \pm 10.7}{r}$$

with  $f_{\rm RF}$  receive frequency

 $f_{LO}$  local oscillator (PLL) frequency ( $f_{RF} \pm 10.7$ )

 $f_{\rm OU}$  quartz crystal oscillator frequency

r ratio of local oscillator (PLL) frequency and crystal frequency as shown in the subsequent table

#### Table 6 Dependence of PLL Overall Division Ratio on FSEL

| FSEL | Ratio r=(f <sub>LO</sub> /f <sub>QU</sub> ) |
|------|---|
| open | 32  |
| GND  | 64  |

This yields the following examples:

FSEL is "Low":

$$f_{QU} = \frac{868.4MHz - 10.7MHz}{64} = 13.4015625 \ MHz$$

FSEL is "High":

$$f_{QU} = \frac{434.2MHz - 10.7MHz}{32} = 13.234375 \text{ MHz}$$



## 3.5 Data Slicer Threshold Generation

The threshold of the data slicer can be generated using an external R-C integrator as shown in Figure 7.

The time constant  $T_A$  of this circuit including also the internal resistors  $R_{F3int}$  and  $R_{F4int}$  (see Figure 9) has to be significantly larger than the longest period of no signal change  $T_L$  within the data sequence.

In order to keep distortion low, the minimum value for R is  $20k\Omega$ .

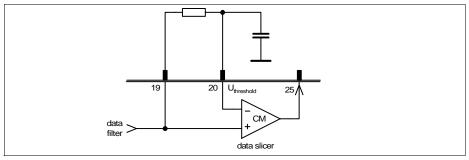
T<sub>A</sub> has to be calculated as

$$T_{A} = \frac{R1 \cdot (R_{F3int} + R_{F4int})}{R1 + R_{F3int} + R_{F4int}} \cdot C13 = R1II(R_{F3int} + R_{F4int}) \cdot C13 \qquad \dots for \ ASK$$

and

$$T_A = \frac{R1 \cdot R_{F4\text{int}}}{R1 + R_{F3\text{int}} + R_{F4\text{int}}} \cdot C13 \qquad = \frac{R1II(R_{F3\text{int}} + R_{F4\text{int}})}{v} \cdot C13 \qquad \dots for \ FSK$$

R1,  $R_{F3 int}$ ,  $R_{F4 int}$  and C13 see also Figure 7 and .Figure 9



#### Figure 7 Data Slicer Threshold Generation with External R-C Integrator

In case of ASK operation another possibility for threshold generation is to use the peak detector in connection with an internal resistive divider and one capacitor as shown in the following Figure 8. For selecting the peak detector as reference for the slicing level a logic low as to be applied on the SSEL pin.

In case of MSEL is high (or open), which means that ASK-Mode is selected, a logic low on the SSEL pin yields a logic high on the AND-output and thus the peak-detector is selected (see Figure 9).

In case of FSK the MSEL-pin and furthermore the one input of the AND-gate is low, so the peak detector can not be selected.

The capacitor value is depending on the coding scheme and the protocol used.



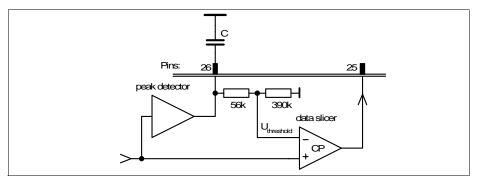


Figure 8 Data Slicer Threshold Generation Utilising the Peak Detector

## 3.6 ASK/FSK-Data Path Functional Description

The TDA5220 is containing an ASK/FSK switch which can be controlled via Pin 15 (MSEL). This switch is actually consisting of 2 operational amplifiers that are having a gain of 1 in case of the ASK amplifier and a gain of 11 in case of the FSK amplifier in order to achieve an appropriate demodulation gain characteristic. In order to compensate for the DC-offset generated especially in case of the FSK PLL demodulator there is a feedback connection between the threshold voltage of the bit slicer comparator (Pin 20) to the negative input of the FSK switch amplifier.

In ASK-mode alternatively to the voltage at Pin 20 (SLN) a value of approx. 87% of the peak-detector output-voltage at Pin 26 (PDO) can be used as the slicer-reference level.

The slicing reference level is generated by an internal voltage divider ( $R_{T1int}$ ,  $R_{T2int}$ ), which is applied on the peak detector output.

The selection between these modes is controlled by Pin 16 (SSEL), as described in Section 3.5.

This is shown in the following Figure 9.



## TDA 5220

## Applications

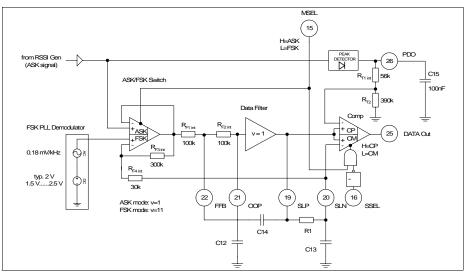


Figure 9 ASK/FSK mode datapath

## 3.7 FSK Mode

The FSK datapath has a bandpass characterisitc due to the feedback shown above (highpass) and the data filter (lowpass). The lower cutoff frequency f2 is determined by the external RC-combination. The upper cutoff frequency f3 is determined by the data filter bandwidth.

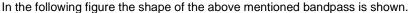
The demodulation gain of the FSK PLL demodulator is  $200\mu$ V/kHz. This gain is increased by the gain v of the FSK switch, which is 11. Therefore the resulting dynamic gain of this circuit is 2.2mV/kHz within the bandpass. The gain for the DC content of FSK signal remains at  $200\mu$ V/kHz. The cut-off frequencies of the bandpass have to be chosen such that the spectrum of the data signal is influenced in an acceptable amount.

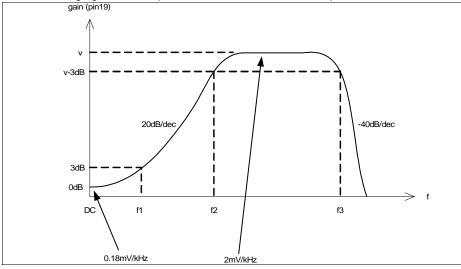
In case that the user data is containing long sequences of logical zeroes the effect of the drift-off of the bit slicer threshold voltage can be lowered if the offset voltage inherent at the negative input of the slicer comparator (Pin20) is used. The comparator has no hysteresis built in.

This offset voltage is generated by the bias current of the negative input of the comparator (i.e. 20nA) running over the external resistor R. This voltage raises the voltage appearing at pin 20 (e.g. 1mV with R =  $100k\Omega$ ). In order to obtain benefit of this



asymmetrical offset for the demodulation of long zeros the lower of the two FSK frequencies should be chosen in the transmitter as the zero-symbol frequency.







The cutoff frequencies are calculated with the following formulas:

$$f_1 = \frac{1}{2\pi \frac{R1 \times 330k\Omega}{R1 + 330k\Omega} \times C13}$$

$$f_2 = v \times f_1 = 11 \times f_1$$

$$f_3 = f_{3dB}$$

 $f_3$  is the 3dB cutoff frequency of the data filter - see Section 3.2.

Example: R1 =  $100k\Omega$ , C13 = 47nFThis leads tof<sub>1</sub> = 44Hz and f<sub>2</sub> = 485Hz

Preliminary Specification



## 3.8 ASK Mode

In case the receiver is operated in ASK mode the datapath frequency charactersitic is dominated by the data filter alone, thus it is lowpass shaped. The cutoff frequency is determined by the external capacitors  $C_{12}$  and  $C_{14}$  and the internal 100k resistors as described in Section 3.2

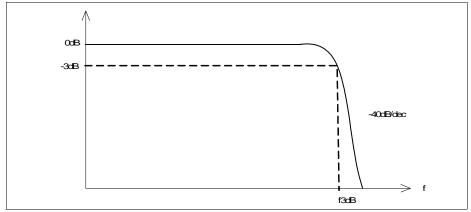


Figure 11 Frequency characteristic in case of ASK mode

## 3.9 Principle of the Precharge Circuit

In case the data slicer threshold shall be generated with an external RC network as described in Section 3.5 it is necessary to use large values for the capacitor C attached to the **SLN** pin (pin 20) in order to achieve long time constants. This results also from the fact that the choice of the value for R1 connected between the **SLP** and **SLN** pins (pins 19 and 20) is limited by the 330k $\Omega$  resistor appearing in parallel to R1 as can be seen in Figure 9. Apart from this a resistor value of 100k $\Omega$  leads to a voltage offset of 1mv at the comparator input. The resulting startup time constant  $\tau_1$  can be calculated with:

$$\tau_1 = (R1 \parallel 330 k\Omega) \times C13$$

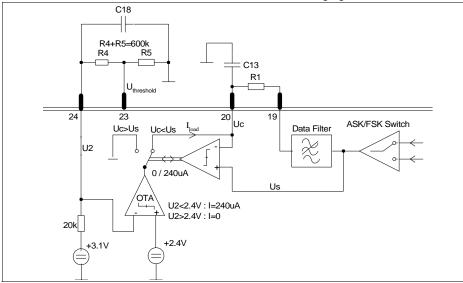
In case R1 is chosen to be  $100 k\Omega$  and C13 is chosen as 47 nF this leads to

$$\tau_1 = (100k\Omega \parallel 330k\Omega) \times 47nF = 77k\Omega \times 47nF = 3.6ms$$

When the device is turned on this time constant dominates the time necessary for the device to be able to demodulate data properly. In the powerdown mode the capacitor is only discharged by leakage currents.



In order to reduce the turn-on time in the presence of large values of C a precharge circuit was included in the TDA5220 as shown in the following figure.



#### Figure 12 Principle of the precharge circuit

This circuit charges the capacitor C13 with an inrush current  $I_{load}$  of typically 220µA for a duration of  $T_2$  until the voltage  $U_c$  appearing on the capacitor is equal to the voltage  $U_s$  at the input of the data filter. This voltage is limited to 2.5V. As soon as these voltages are equal or the duration  $T_2$  is exceeded the precharge circuit is disabled.

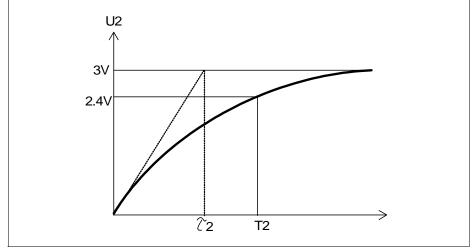
 $\tau_2$  is the time constant of the charging process of C18 which can be calculated as

$$\tau_2 \approx 20k\Omega \times C2$$

as the sum of R4 and R5 is sufficiently large and thus can be neglected.  $T_2$  can then be calculated according to the following formula:

$$T_2 = \tau_2 \ln \left(\frac{1}{1 - \frac{2.4V}{3V}}\right) \approx \tau_2 \times 1.6$$





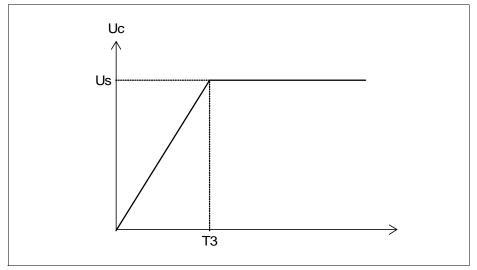
The voltage transient during the charging of  $C_2$  is shown in the following figure:

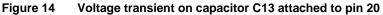
#### Figure 13 Voltage appearing on C18 during precharging process

The voltage appearing on the capacitor C13 connected to pin 20 is shown in the following figure. It can be seen that due to the fact that it is charged by a constant current source it exhibits is a linear increase in voltage which is limited to  $U_{Smax} = 2.5V$  which is also the approximate operating point of the data filter input. The time constant appearing in this case can be denoted as  $T_3$ , which can be calculated with:

$$T_3 = \frac{U_{S\max} \times C13}{220\mu A} = \frac{2.5V}{220\mu A} \times C13$$







As an example the choice of C18 = 22nF and C13 = 47nF yields

 $\tau_2 = 0.44 \text{ms}$  $T_2 = 0.71 \text{ms}$  $T_3 = 0.53 \text{ms}$ 

This means that in this case the inrush current could flow for a duration of 0.64ms but stops already after 0.49ms when the  $U_{Smax}$  limit has been reached. T<sub>3</sub> should always be chosen to be shorter than T<sub>2</sub>.

It has to be noted finally that during the turn-on duration  $T_2$  the overall device power consumption is increased by the 220µA needed to charge C13.

The precharge circuit may be disabled if C18 is not equipped. This yields a T<sub>2</sub> close to zero. Note that the sum of R<sub>4</sub> and R<sub>5</sub> has to be 600k $\Omega$  in order to produce 3V at the THRES pin as this voltage is internally used also as the reference for the FSK demodulator.



## 4 Reference

## 4.1 Electrical Data

## 4.1.1 Absolute Maximum Ratings

#### Attention: The maximum ratings may not be exceeded under any circumstances, not even momentarily and individually, as permanent damage to the IC may result. The AC/DC characteristic limits are not guaranteed.

| Table 7 | Absolute Maximum Ratings, T <sub>amb</sub> = -40 °C +105 °C |
|---------|---|
|---------|---|

| # | Parameter  | Symbol            | Limit | Values | Unit | Remarks                           |
|---|--|-------------------|-------|--------|------|-----------------------------------|
|   |  |                   | min.  | max.   |      |                                   |
| 1 | Supply Voltage                                   | Vs                | -0.3  | 5.5    | V    |                                   |
| 2 | Junction Temperature                             | Tj                | -40   | +125   | °C   |                                   |
| 3 | Storage Temperature                              | Ts                | -40   | +150   | °C   |                                   |
| 4 | Thermal Resistance                               | R <sub>thJA</sub> |       | 114    | K/W  |                                   |
| 5 | ESD integrity, all pins<br>excl. Pins 1,3, 6, 28 | V <sub>ESD</sub>  |       | +2     | kV   | HBM according to<br>MIL STD 883D, |
|   | ESD integrity Pins<br>1,3,6,28                   |                   |       | +1.5   | kV   | method 3015.7                     |

## 4.1.2 Operating Range

Within the operational range the IC operates as explained in the circuit description. Currents flowing into the device are denoted as positive currents and vice versa. The device parameters with  $\blacksquare$  are not part of the production test, but either verified by design or measured in the Infineon Evalboard as described in Section 4.2.

Supply voltage: VCC = 4.5V .. 5.5V



| # | Parameter   | Symbol   | Limit \                  | /alues                   | Unit                 | Test Conditions/   | L |
|---|---|--|--------------------------|--------------------------|----------------------|--|---|
|   |   |  | min.                     | max.                     |                      | Notes  |   |
| 1 | Supply Current  | I <sub>SF</sub> 868<br>I <sub>SF</sub> 434<br>I <sub>SA</sub> 868<br>I <sub>SA</sub> 434 | 3.9<br>3.7<br>3.2<br>3.0 | 7.9<br>7.7<br>7.2<br>7.0 | mA<br>mA<br>mA<br>mA | $\label{eq:resonance} \begin{array}{l} f_{\text{RF}}{=}868\text{MHz}, \text{FSK Mode} \\ f_{\text{RF}}{=}434\text{MHz}, \text{FSK Mode} \\ f_{\text{RF}}{=}868\text{MHz}, \text{ASK Mode} \\ f_{\text{RF}}{=}434\text{MHz}, \text{ASK Mode} \end{array}$ |   |
| 2 | Receiver Input Level<br>ASK<br>FSK, frequ. dev. ± 50kHz | RF <sub>in</sub>   | -106<br>-100             | -13<br>-13               | dBm<br>dBm           | © source impedance<br>50Ω<br>BER 2E-3, average<br>power level, Manchester<br>encoded datarate 4kBit,<br>280KHz IF Bandwidth  |   |
| 3 | LNI Input Frequency                                     | f <sub>RF</sub>  | 400/810                  | 440/870                  | MHz                  |  |   |
| 4 | MI/X Input Frequency                                    | f <sub>MI</sub>  | 400/810                  | 440/870                  | MHz                  |  |   |
| 5 | 3dB IF Frequency Range<br>ASK<br>FSK                    | f <sub>IF -3dB</sub>   | 5<br>10.4                | 23<br>11                 | MHz                  |  |   |
| 6 | Powerdown Mode On                                       | PWDN <sub>ON</sub>   | 2                        | Vs                       | V                    |  |   |
| 7 | Powerdown Mode Off                                      | PWDN <sub>OFF</sub>  | 0                        | 0.8                      | V                    |  |   |
| 8 | Gain Control Voltage,<br>LNA high gain state            | V <sub>THRES</sub>   | 2.8                      | Vs                       | V                    |  |   |
| 9 | Gain Control Voltage,<br>LNA low gain state             | V <sub>THRES</sub>   | 0                        | 0.7                      | V                    |  |   |

## Table 8Operating Range, $T_{amb} = -40 \ ^{\circ}C \ \dots \ +105 \ ^{\circ}C$

■ Not part of the production test - either verified by design or measured in the Infineon Evalboard as described in Section 4.2.

## **4.1.3 AC/DC Characteristics** at $T_{AMB} = 25^{\circ}C$

AC/DC characteristics involve the spread of values guaranteed within the specified voltage and ambient temperature range. Typical characteristics are the median of the production. Currents flowing into the device are denoted as po-sitive currents and vice versa. The device performance parameters marked with  $\blacksquare$  are not part of the production test - either verified by design or measured in the Infineon Evalboard as described in Section 4.2.



## Table 9 AC/DC Characteristics with $T_A 25^{\circ}C$ , $V_{VCC}$ =4.5 ... 5.5 V

| # | Parameter | Symbol | Limit Values |      | ymbol Limit Values |  | Unit  |  | L |
|---|-----------|--------|--------------|------|--------------------|--|-------|--|---|
|   |           |        | min.         | typ. | max.               |  | Notes |  |   |
|   |           |        |              |      |                    |  |       |  |   |

## SUPPLY

| Su | pply Current  |                     |     |     |     |    |  |
|----|---|---------------------|-----|-----|-----|----|--|
| 1  | Supply current, standby mode                                      | I <sub>S PDWN</sub> |     | 50  | 100 | nA | Pin 27 (PDWN)<br>open or tied to 0 V                       |
| 2  | Supply current, device<br>operating in 868 MHz<br>range, FSK mode | I <sub>SF 868</sub> | 5.1 | 5.9 | 6.7 | mA | Pin 11 (FSEL) tied to<br>GND, Pin 15 (MSEL)<br>tied to GND |
| 3  | Supply current, device<br>operating in 434 MHz<br>range, FSK mode | I <sub>SA 434</sub> | 4.9 | 5.7 | 6.5 | mA | Pin 11 (FSEL) open,<br>Pin 15 (MSEL) tied<br>to GND        |
| 4  | Supply current, device<br>operating in 868 MHz<br>range, ASK mode | I <sub>SA 868</sub> | 4.4 | 5.2 | 6   | mA | Pin 11 (FSEL) tied to<br>GND, Pin 15<br>(MSEL) open        |
| 5  | Supply current, device<br>operating in 434 MHz<br>range, ASK mode | I <sub>SA 434</sub> | 4.2 | 5.  | 5.8 | mA | Pin 11 (FSEL) open,<br>Pin 15 (MSEL) open                  |

## LNA

## Signal Input LNI (PIN 3), V<sub>THRES</sub>>2.8V, high gain mode

| 1 | Average Power Level<br>at BER = 2E-3<br>(Sensitivity)     | RF <sub>in</sub>    |                   | -110 |   | dBm | Manchester<br>encoded datarate<br>4kBit, 280kHz IF<br>Bandwidth             |  |
|---|---|---------------------|-------------------|------|---|-----|---|--|
| 2 | Average Power Level<br>at BER = 2E-3<br>(Sensitivity) FSK | RF <sub>in</sub>    |                   | -103 |   | dBm | Manchester enc.<br>datarate 4kBit,<br>280kHz IF Bandw., ±<br>50kHz pk. dev. |  |
| 3 | Input impedance,<br>f <sub>RF</sub> = 434 MHz             | S <sub>11 LNA</sub> | 0.873 / -34.7 deg |      |   |     |   |  |
| 4 | Input impedance,<br>f <sub>RF</sub> = 869 MHz             | S <sub>11 LNA</sub> | 0.738 / -73.5 deg |      | g |     |   |  |
| 5 | Input level @ 1dB<br>compression                          | P1dB <sub>LNA</sub> |                   | -15  |   | dBm |   |  |



| #   | Parameter  | Symbol                    | Li                | mit Val   | ues   | Unit | Test Conditions/ | L |
|-----|--|---------------------------|-------------------|-----------|-------|------|------------------|---|
|     |  |                           | min.              | typ.      | max.  | -    | Notes            |   |
| 6   | Input 3 <sup>rd</sup> order intercept<br>point f <sub>RF</sub> = 434 MHz | IIP3 <sub>LNA</sub>       |                   | -10       |       | dBm  | matched input    |   |
| 7   | Input 3 <sup>rd</sup> order intercept<br>point f <sub>RF</sub> = 869 MHz | IIP3 <sub>LNA</sub>       |                   | -14       |       | dBm  | matched input    |   |
| 8   | LO signal feedthrough at antenna port                                    | LO <sub>LNI</sub>         |                   |           | -73   | dBm  |                  |   |
| Sig | gnal Output LNO (PIN 6   | ), V <sub>THRES</sub> >2. | 8V, hig           | h gain n  | node  |      | 1                |   |
| 1   | Gain f <sub>RF</sub> = 434 MHz   | S <sub>21 LNA</sub>       | 1.50              | 09/ 138.2 | 2 deg |      |                  |   |
| 2   | Gain f <sub>RF</sub> = 869 MHz   | S <sub>21 LNA</sub>       | 1.4               | 19/ 101.  | 7 deg |      |                  |   |
| 3   | Output impedance,<br>f <sub>RF</sub> = 434 MHz                           | S <sub>22 LNA</sub>       | 0.886 / -12.9 deg |           |       |      |                  |   |
| 4   | Output impedance,<br>f <sub>RF</sub> = 869 MHz                           | S <sub>22 LNA</sub>       | 0.866 / -24.2 deg |           |       |      |                  |   |
| 5   | Voltage Gain Antenna<br>to MI f <sub>RF</sub> = 434 MHz                  | G <sub>AntMI</sub>        |                   | 42        |       | dB   |                  |   |
| 6   | Voltage Gain Antenna<br>to MI f <sub>RF</sub> = 869 MHz                  | G <sub>AntMI</sub>        |                   | 40        |       | dB   |                  |   |
| Sig | gnal Input LNI, V <sub>THRES</sub> =0                                    | SND, Iwo ga               | ain mod           | le        |       | 1    |                  |   |
| 1   | Input impedance,<br>f <sub>RF</sub> = 434 MHz                            | S <sub>11 LNA</sub>       | 0.873             | ′ -34.7 d | eg    |      |                  |   |
| 2   | Input impedance,<br>f <sub>RF</sub> = 869 MHz                            | S <sub>11 LNA</sub>       | 0.738             | ′ -73.5 d | eg    |      |                  |   |
| 3   | Input level @ 1dB C. P.<br>f <sub>RF</sub> = 434 MHz                     | P1dB <sub>LNA</sub>       |                   | -18       |       | dBm  | matched input    |   |
| 4   | Input level @ 1dB C. P.<br>f <sub>RF</sub> = 869 MHz                     | P1dB <sub>LNA</sub>       |                   | -6        |       | dBm  | matched input    |   |
| 5   | Input 3 <sup>rd</sup> order intercept<br>point f <sub>RF</sub> = 434 MHz | IIP3 <sub>LNA</sub>       |                   | -10       |       | dBm  | matched input    |   |
| 6   | Input 3 <sup>rd</sup> order intercept<br>point f <sub>RF</sub> = 869 MHz | IIP3 <sub>LNA</sub>       |                   | -5        |       | dBm  | matched input    |   |
| Sig | nal Output LNO, V <sub>THRE</sub>  | <sub>s</sub> =GND, lwo    | o gain m          | node      |       |      |                  |   |
|     |  | •                         | 0.400             |           |       |      |                  | - |

| 1 | Gain f <sub>RF</sub> = 434 MHz                 | S <sub>21 LNA</sub> | 0.183 / 140.6 deg |  |  |
|---|--|---------------------|-------------------|--|--|
| 2 | Gain f <sub>RF</sub> = 869 MHz                 | S <sub>21 LNA</sub> | 0.179 / 109.1 deg |  |  |
| 3 | Output impedance,<br>f <sub>RF</sub> = 434 MHz | S <sub>22 LNA</sub> | 0.897 / -13.6 deg |  |  |



| #   | Parameter   | Symbol                | Li      | mit Val | ues               | Unit | <b>Test Conditions/</b>   | L  |
|-----|---|-----------------------|---------|---------|-------------------|------|---------------------------|----|
|     |   |                       | min.    | typ.    | max.              |      | Notes                     |    |
| 4   | Output impedance,<br>f <sub>RF</sub> = 869 MHz          | S <sub>22 LNA</sub>   | 0.868 / | -26.3 d | leg               |      |                           |    |
| 5   | Voltage Gain Antenna<br>to MI f <sub>RF</sub> = 434 MHz | G <sub>AntMI</sub>    |         | 22      |                   | dB   |                           |    |
| 6   | Voltage Gain Antenna<br>to MI f <sub>RF</sub> = 869 MHz | G <sub>AntMI</sub>    |         | 19      |                   | dB   |                           |    |
| Sig | gnal 3VOUT (PIN 24)                                     | 1                     | 1       |         |                   |      |                           | -1 |
| 1   | Output voltage  | V <sub>3VOUT</sub>    | 2.9     | 3.1     | 3.3               | V    | 3VOUT Pin open            | T  |
| 2   | Current out   | I <sub>3VOUT</sub>    | -3      | -5      | -10               | μA   | see Section 4.1           |    |
| Sig | nal THRES (PIN 23)                                      |                       |         |         |                   |      |                           |    |
| 1   | Input Voltage range                                     | V <sub>THRES</sub>    | 0       |         | V <sub>S</sub> -1 | V    | see Section 4.1           |    |
| 2   | LNA low gain mode                                       | V <sub>THRES</sub>    |         |         | 0                 | V    |                           |    |
| 3   | LNA high gain mode                                      | V <sub>THRES</sub>    | 3       |         | V <sub>S</sub> -1 | V    | or shorted to Pin 24      |    |
| 4   | Current in  | I <sub>THRES_in</sub> |         | 5       |                   | nA   |                           |    |
| Sig | gnal TAGC (PIN 4)                                       |                       |         |         |                   |      |                           |    |
| 1   | Current out,<br>LNA low gain state                      | I <sub>TAGC_out</sub> | -3.6    | -4.2    | -5.5              | μA   | RSSI > V <sub>THRES</sub> |    |
| 2   | Current in,<br>LNA high gain state                      | I <sub>TAGC_in</sub>  | 1       | 1.6     | 2.2               | μA   | RSSI < V <sub>THRES</sub> |    |

## Signal Input MI/MIX (PINS 8/9)

| 1 | Input impedance,<br>f <sub>RF</sub> = 434 MHz                            | S <sub>11 MIX</sub> | 0.942 / -14.4 deg |     |  |
|---|--|---------------------|-------------------|-----|--|
| 2 | Input impedance,<br>f <sub>RF</sub> = 869 MHz                            | S <sub>11 MIX</sub> | 0.918 / -28.1 deg |     |  |
| 3 | Input 3 <sup>rd</sup> order intercept<br>point f <sub>RF</sub> = 434 MHz | IIP3 <sub>MIX</sub> | -28               | dBm |  |
| 4 | Input 3 <sup>rd</sup> order intercept<br>point f <sub>RF</sub> = 869 MHz | IIP3 <sub>MIX</sub> | -26               | dBm |  |

## Signal Output IFO (PIN 12)

| 1 | Output impedance                                     | Z <sub>IFO</sub> | 330 | Ω  |  |
|---|--|------------------|-----|----|--|
| 2 | Conversion Voltage<br>Gain f <sub>RF</sub> = 434 MHz | G <sub>MIX</sub> | 19  | dB |  |



| Parameter  | Symbol           |      | Limit Values |      |    | Test Conditions/ | L |
|--|------------------|------|--------------|------|----|------------------|---|
|  |                  | min. | typ.         | max. |    | Notes            |   |
| Conversion Voltage<br>Gain f <sub>RF</sub> = 869 MHz | G <sub>MIX</sub> |      | 18           |      | dB |                  |   |

### LIMITER

| Sig | gnal Input LIM/X (PINS <sup>·</sup> | 17/18)              |     |            |     |     |  |
|-----|-------------------------------------|---------------------|-----|------------|-----|-----|--|
| 1   | Input Impedance                     | Z <sub>LIM</sub>    | 264 | 330        | 396 | Ω   |  |
| 2   | RSSI dynamic range                  | DR <sub>RSSI</sub>  |     | 70         |     | dB  |  |
| 3   | RSSI linearity                      | LIN <sub>RSSI</sub> |     | <b>±</b> 1 |     | dB  |  |
| 4   | Operating frequency<br>(3dB points) | f <sub>LIM</sub>    | 5   | 10.7       | 23  | MHz |  |

# DATA FILTER

| 1 | Useable bandwidth   | BW <sub>BB</sub><br>FILT |      | 100 | kHz |                                     |  |
|---|---|--------------------------|------|-----|-----|-------------------------------------|--|
| 2 | RSSI Level at Data<br>Filter Output SLP,<br>RF <sub>IN</sub> =-103dBm | RSSI <sub>low</sub>      | 1.1  |     | V   | LNA in high gain<br>mode at 868 MHz |  |
| 3 | RSSI Level at Data<br>Filter Output SLP,<br>RF <sub>IN</sub> =-30dBm  | RSSI <sub>high</sub>     | 2.65 |     | V   | LNA in high gain<br>mode at 868 MHz |  |

### SLICER

### Signal Output DATA (PIN 25)

| 1   | Maximum Datarate         | DR <sub>max</sub>    |                         |                   | 100                     | kBps | NRZ, 20pF<br>capacitive loading |  |
|-----|--------------------------|----------------------|-------------------------|-------------------|-------------------------|------|---------------------------------|--|
| 2   | LOW output voltage       | V <sub>SLIC_L</sub>  | 0                       |                   | 0.1                     | V    |                                 |  |
| 3   | HIGH output voltage      | V <sub>SLIC_H</sub>  | V <sub>S</sub> -<br>1.3 | V <sub>S</sub> -1 | V <sub>S</sub> -<br>0.7 | V    | output<br>current=200µA         |  |
| Sli | cer, Negative Input (PIN | 20)                  |                         |                   |                         |      |                                 |  |
| 1   | Precharge Current Out    | I <sub>PCH_SLN</sub> | -100                    | -220              | -300                    | μA   | see Section 4.2.                |  |



| # | Parameter | Symbol | Limit Values |      |      | Unit | Test Conditions/ | L |
|---|-----------|--------|--------------|------|------|------|------------------|---|
|   |           |        | min.         | typ. | max. |      | Notes            |   |
|   |           |        |              |      |      |      |                  |   |

### PEAK DETECTOR

#### Signal Output PDO (PIN 26)

| 1 | Load current            | I <sub>load</sub> | -500 |     |     | μA | static load current<br>must not exceed<br>-500µA |
|---|-------------------------|-------------------|------|-----|-----|----|--|
| 2 | Internal resistive load | R                 | 357  | 446 | 535 | kΩ |  |
| - |                         |                   |      |     |     |    |  |

### **CRYSTAL OSCILLATOR**

#### Signals CRSTL 1, CRSTL 2 (PINS 1/28)

| 1 | Operating frequency         | fcrstl               | 6 |                  | 14  | MHz | fundamental mode,<br>series resonance |
|---|-----------------------------|----------------------|---|------------------|-----|-----|---------------------------------------|
| 2 | Input Impedance<br>@ ~13MHz | Z <sub>1-28</sub>    |   | -600 +<br>j 1010 |     | Ω   |                                       |
| 3 | Serial Capacity<br>@ ~13MHz | C <sub>S10</sub> =C1 |   |                  | 5.9 | pF  |                                       |

# ASK/FSK Signal Switch

#### Signal MSEL (PIN 15)

| 1 | ASK Mode                   | V <sub>MSEL</sub> | 1.4 |     | 4   | V  | or open          |  |
|---|----------------------------|-------------------|-----|-----|-----|----|------------------|--|
| 2 | FSK Mode                   | V <sub>MSEL</sub> | 0   |     | 0.2 | V  |                  |  |
| 3 | Input Bias Current<br>MSEL | I <sub>MSEL</sub> |     | -11 | 19  | μA | MSEL tied to GND |  |

#### FSK DEMODULATOR

| 1 | Demodulation Gain    | G <sub>FMDEM</sub> |      | 200  |      | μV/<br>kHz |  |
|---|----------------------|--------------------|------|------|------|------------|--|
| 2 | Useable IF Bandwidth | BWIFPLL            | 10.2 | 10.7 | 11.2 | MHz        |  |

#### POWER DOWN MODE

#### Signal PDWN (PIN 27)

| 1 | Powerdown Mode On  | PWDN <sub>ON</sub>  | 2.8 | VS  | V |  |
|---|--------------------|---------------------|-----|-----|---|--|
| 2 | Powerdown Mode Off | PWDN <sub>Off</sub> | 0   | 0.8 | V |  |



| # | Parameter   | Symbol            | Li   | Limit Values |      |    | Test Conditions/            | L |
|---|---|-------------------|------|--------------|------|----|-----------------------------|---|
|   |   |                   | min. | typ.         | max. |    | Notes                       |   |
| 3 | Input bias current<br>PDWN                            | I <sub>PDWN</sub> |      | 19           |      | μA | Power On Mode               |   |
| 4 | Start-up Time until<br>valid IF signal is<br>detected | T <sub>SU</sub>   |      | <1           |      | ms | depends on the used crystal |   |

### VCO MULTIPLEXER

#### Signal FSEL (PIN 11)

|   | , ,                           |                   |      |      |      |    |                  |
|---|-------------------------------|-------------------|------|------|------|----|------------------|
| 1 | f <sub>RF</sub> range 434 MHz | V <sub>FSEL</sub> | 1.4  |      | 4    | V  | or open          |
| 2 | f <sub>RF</sub> range 869 MHz | V <sub>FSEL</sub> | 0    |      | 0.2  | V  |                  |
| 3 | Input bias current<br>FSEL    | I <sub>FSEL</sub> | -160 | -200 | -240 | μA | FSEL tied to GND |
|   |                               |                   |      |      |      |    |                  |

### DATA-SLICER REFERENCE-LEVEL

#### Signal SSEL (PIN 16), ASK-Mode

| 1 | Slicer-Reference is voltage at Pin 20 (SLN)                             | V <sub>SSEL</sub> | 1.4 |     | 4   | V  | or open          |
|---|---|-------------------|-----|-----|-----|----|------------------|
| 2 | Slicer-Reference is<br>approx. 87% of the<br>voltage at Pin 26<br>(PDO) | V <sub>SSEL</sub> | 0   |     | 0.2 | V  |                  |
| 3 | Input bias current<br>SSEL  | I <sub>SSEL</sub> |     | -10 | -19 | μA | SSEL tied to GND |

■ Not part of the production test - either verified by design or measured in the Infineon Evalboard as described in Section 4.2.



# 4.1.4 AC/DC Characteristics at T<sub>AMB</sub>= -40 to 105°C

Currents flowing into the device are denoted as positive currents and vice versa.

# Table 10AC/DC Characteristics with $T_{AMB} = -40^{\circ}C \dots + 105^{\circ}C$ , $V_{VCC} = 4.5 \dots 5.5 V$

| # | Parameter | Symbol | Limit Values |      |      | Unit | Test Conditions/ |  |
|---|-----------|--------|--------------|------|------|------|------------------|--|
|   |           |        | min.         | typ. | max. |      | Notes            |  |
|   |           |        |              |      |      |      |                  |  |

# SUPPLY

| Su  | pply Current   |                       |     |      |                   |    |  |
|-----|--|-----------------------|-----|------|-------------------|----|--|
| 1   | Supply current, standby mode   | I <sub>S PDWN</sub>   |     | 50   | 400               | nA | Pin 27 (PDWN) open<br>or tied to 0 V                       |
| 2   | Supply current,<br>device operating in<br>868 MHz range, FSK<br>mode | I <sub>SF 868</sub>   | 3.9 | 5.9  | 7.9               | mA | Pin 11 (FSEL) tied to<br>GND, Pin 15 (MSEL)<br>tied to GND |
| 3   | Supply current,<br>device operating in<br>434 MHz range, FSK<br>mode | I <sub>SA 434</sub>   | 3.7 | 5.7  | 7.7               | mA | Pin 11 (FSEL) open,<br>Pin 15 (MSEL) tied<br>to GND        |
| 4   | Supply current,<br>device operating in<br>868 MHz range, ASK<br>mode | I <sub>SA 868</sub>   | 3.2 | 5.2  | 7.2               | mA | Pin 11 (FSEL) tied to<br>GND, Pin 15<br>(MSEL) open        |
| 5   | Supply current,<br>device operating in<br>434 MHz range, ASK<br>mode | I <sub>SA 434</sub>   | 3   | 5.   | 7                 | mA | Pin 11 (FSEL) open,<br>Pin 15 (MSEL) open                  |
| Sig | gnal Input 3VOUT (PIN  | 24)                   |     |      |                   |    |  |
| 1   | Output voltage   | V <sub>3VOUT</sub>    | 2.9 | 3.1  | 3.3               | V  | 3VOUT Pin open   |
| 2   | Current out  | I <sub>3VOUT</sub>    | -3  | -5   | -10               | μA | see Section 4.1  |
| Sig | gnal THRES (PIN 23)  |                       |     |      |                   |    |  |
| 1   | Input Voltage range  | V <sub>THRES</sub>    | 0   |      | V <sub>S</sub> -1 | V  | see Section 4.1  |
| 2   | LNA low gain mode  | V <sub>THRES</sub>    |     |      | 0                 | V  |  |
| 3   | LNA high gain mode   | V <sub>THRES</sub>    | 3   |      | V <sub>S</sub> -1 | V  | or shorted to Pin 24                                       |
| 4   | Current in   | I <sub>THRES_in</sub> |     | 5    |                   | nA |  |
| Sig | gnal TAGC (PIN 4)  | •                     |     | ÷    | •                 |    |  |
| 1   | Current out,<br>LNA low gain state                                   | I <sub>TAGC_out</sub> | -1  | -4.2 | -8                | μA | RSSI > V <sub>THRES</sub>                                  |



| #  | Parameter                       | Symbol               | Limit Values |      |      | Unit | Test Conditions/          |  |
|----|---------------------------------|----------------------|--------------|------|------|------|---------------------------|--|
|    |                                 |                      | min.         | typ. | max. |      | Notes                     |  |
| 2  | Current in, LNA high gain state | V <sub>TAGC_in</sub> | 0.5          | 1.5  | 5    | μA   | RSSI < V <sub>THRES</sub> |  |
| MD | KER                             |                      |              |      |      |      |                           |  |

| 1 | Conversion Voltage<br>Gain f <sub>RF</sub> = 434 MHz | G <sub>MIX</sub> | +19 | dB |  |
|---|--|------------------|-----|----|--|
| 2 | Conversion Voltage<br>Gain f <sub>RF</sub> = 868 MHz | G <sub>MIX</sub> | +18 | dB |  |

### LIMITER

# Signal Input LIM/X (PINS 17/18)

| 1 | RSSI dynamic range   | DR <sub>RSSI</sub>   | 70   | dB |                                     |
|---|--|----------------------|------|----|-------------------------------------|
| 2 | RSSI Level at Data<br>Filter Output SLP,<br>RF <sub>IN</sub> = -103dBm | RSSI <sub>low</sub>  | 1.1  | V  | LNA in high gain<br>mode at 868 MHz |
| 3 | RSSI Level at Data<br>Filter Output SLP,<br>RF <sub>IN</sub> = -30dBm  | RSSI <sub>high</sub> | 2.65 | V  | LNA in high gain<br>mode at 868 MHz |

### DATA FILTER

### Slicer, Signal Output DATA (PIN 25)

| 1 | Maximum Datarate    | DR <sub>max</sub>   |                         |                   | 100                     | kBps | NRZ, 20pF<br>capacitive loading |  |
|---|---------------------|---------------------|-------------------------|-------------------|-------------------------|------|---------------------------------|--|
| 2 | LOW output voltage  | V <sub>SLIC_L</sub> | 0                       |                   | 0.1                     | V    |                                 |  |
| 3 | HIGH output voltage | V <sub>SLIC_H</sub> | V <sub>S</sub> -<br>1.5 | V <sub>S</sub> -1 | V <sub>S</sub> -<br>0.5 | V    | output<br>current=200µA         |  |

### Slicer, Negative Input (PIN 20)

| 1 | Precharge Current<br>Out | I <sub>PCH_SLN</sub> | -100 | -220 | -300 | μA | see Section 4.2 |  |
|---|--------------------------|----------------------|------|------|------|----|-----------------|--|
|---|--------------------------|----------------------|------|------|------|----|-----------------|--|



| # | Parameter | Symbol | Limit Values |      |      | Unit | Test Conditions/ |  |
|---|-----------|--------|--------------|------|------|------|------------------|--|
|   |           |        | min.         | typ. | max. |      | Notes            |  |
|   |           |        |              |      |      |      |                  |  |

### PEAK DETECTOR

### Signal Output PDO (PIN 26)

| 1 | Load current            | l <sub>load</sub> | -400 |     |     | μA | static load current<br>must not exceed<br>-500µA |
|---|-------------------------|-------------------|------|-----|-----|----|--|
| 2 | Internal resistive load | R                 | 356  | 446 | 575 | kΩ |  |
|   |                         |                   |      |     |     |    |  |

### **CRYSTAL OSCILLATOR**

### Signals CRSTL 1, CRSTL 2 (PINS 1/28)

| 1 | Operating frequency | <sup>f</sup> CRSTL | 6 | 14 | MHz | fundamental mode, series resonance |  |
|---|---------------------|--------------------|---|----|-----|------------------------------------|--|
|   |                     |                    |   |    |     |                                    |  |

# ASK/FSK Signal Switch

#### Signal MSEL (PIN 15)

| 1 | ASK Mode                   | V <sub>MSEL</sub> | 1.4 |     | 4   | V  | or open          |  |
|---|----------------------------|-------------------|-----|-----|-----|----|------------------|--|
| 2 | FSK Mode                   | V <sub>MSEL</sub> | 0   |     | 0.2 | V  |                  |  |
| 3 | Input bias current<br>MSEL | I <sub>MSEL</sub> |     | -11 | -20 | μA | MSEL tied to GND |  |

### **FSK DEMODULATOR**

| 1 | Demodulation Gain       | G <sub>FMDEM</sub>  |      | 200  |      | μV/<br>kHz |  |
|---|-------------------------|---------------------|------|------|------|------------|--|
| 2 | Useable IF<br>Bandwidth | BW <sub>IFPLL</sub> | 10.2 | 10.7 | 11.2 | MHz        |  |

### POWER DOWN MODE

### Signal PDWN (PIN 27)

| 1 | Powerdown Mode On  | PWDN <sub>ON</sub>  | 2.8 | V <sub>S</sub> | V |  |
|---|--------------------|---------------------|-----|----------------|---|--|
| 2 | Powerdown Mode Off | PWDN <sub>Off</sub> | 0   | 0.8            | V |  |



| # | Parameter  | Symbol          | Limit Values |      |      | Unit | <b>Test Conditions/</b>     |
|---|--|-----------------|--------------|------|------|------|-----------------------------|
|   |  |                 | min.         | typ. | max. |      | Notes                       |
| 3 | Start-up Time until<br>valid signal is<br>detected at IF | T <sub>SU</sub> |              | <1   |      | ms   | depends on the used crystal |

### VCO MULTIPLEXER

| 1 | f <sub>RF</sub> range 434 MHz | V <sub>FSEL</sub> | 1.4  |      | 4    | V  | or open          |
|---|-------------------------------|-------------------|------|------|------|----|------------------|
| 2 | f <sub>RF</sub> range 869 MHz | V <sub>FSEL</sub> | 0    |      | 0.2  | V  |                  |
| 3 | Input bias current<br>FSEL    | I <sub>FSEL</sub> | -110 | -200 | -340 | μA | FSEL tied to GND |

### DATA-SLICER REFERENCE-LEVEL

| Signal SSEL | . (PIN 16) | , ASK-Mode |
|-------------|------------|------------|
|-------------|------------|------------|

| 1 | Slicer-Reference is<br>voltage at Pin 20<br>(SLN)                       | V <sub>SSEL</sub> | 1.4 |     | 4   | V  | or open          |  |
|---|---|-------------------|-----|-----|-----|----|------------------|--|
| 2 | Slicer-Reference is<br>approx. 87% of the<br>voltage at Pin 26<br>(PDO) | V <sub>SSEL</sub> | 0   |     | 0.2 | V  |                  |  |
| 3 | Input bias current<br>SSEL  | I <sub>SSEL</sub> |     | -11 | -20 | μA | SSEL tied to GND |  |

■ Not part of the production test - either verified by design or measured in the Infineon Evalboard as described in Section 4.2.

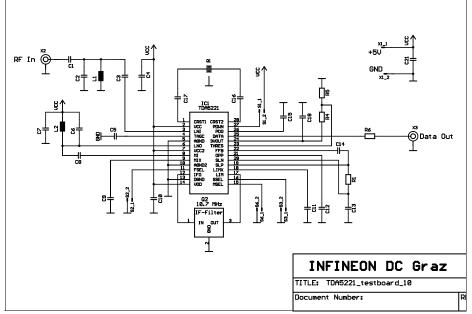
### 4.2 Test Circuit

The device performance parameters marked with  $\blacksquare$  in **Section 4.1** were either verified by design or measured on an Infineon evaluation board. This evaluation board can be obtained together with evaluation boards of the accompanying transmitter device TDK5110 in an evaluation kit that may be ordered on the INFINEON Webpage www.infineon.com/Products. More information on the kit is available on request.



# TDA 5220

### Reference



### Figure 15 Schematic of the Evaluation Board

### 4.3 Test Board Layouts

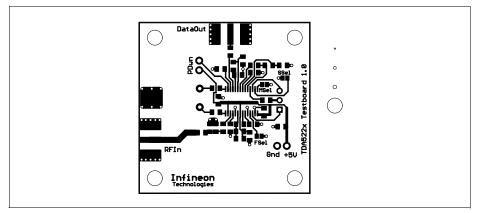


Figure 16 Top Side of the Evaluation Board



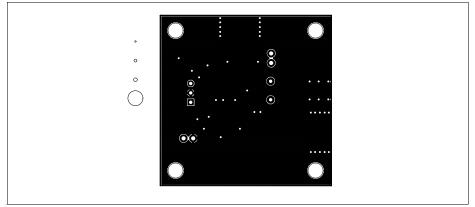


Figure 17 Bottom Side of the Evaluation Board

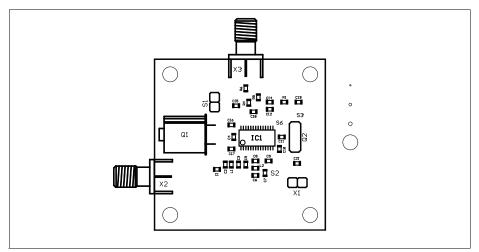


Figure 18 Component Placement on the Evaluation Board



# 4.4 Bill of Materials

The following components are necessary for evaluation of the TDA5220.

| Ref. | Value 434MHz  | Value 868MHz   | Specification        |
|------|---------------|----------------|----------------------|
| C1   | 1pF           | 1pF            | 0805, COG, +/-0.1pF  |
| C2   | 4.7pF         | 3.9pF          | 0805, COG, +/-0.1pF  |
| C3   | 6.8pF         | 5.6pF          | 0805, COG, +/-0.1pF  |
| C4   | 100pF         | 100pF          | 0805, COG, +/-5%     |
| C5   | 47nF          | 47nF           | 1206, X7R, +/-10%    |
| C6   | 10nH          | 3.9pF          | Toko, PTL2012-F10N0G |
| C7   | 100pF         | 100pF          | 0805, COG, +/-5%     |
| C8   | 33pF          | 22pF           | 0805, COG, +/-5%     |
| C9   | 100pF         | 100pF          | 0805, COG, +/-5%     |
| C10  | 10nF          | 10nF           | 0805, X7R, +/-10%    |
| C11  | 10nF          | 10nF           | 0805, X7R, +/-10%    |
| C12  | 220pF         | 220pF          | 0805, COG, +/-5%     |
| C13  | 47nF          | 47nF           | 0805, X7R, +/-10%    |
| C14  | 470pF         | 470pF          | 0805, COG, +/-5%     |
| C15  | 47nF          | 47nF           | 0805, COG, +/-5%     |
| C16  | 8.2pF         | 8.2pF          | 0805, COG, +/-0.1pF  |
| C17  | 18pF          | 18pF           | 0805, COG, +/-1%     |
| C18  | 22nF          | 22nF           | 0805, X7R, +/-5%     |
| C21  | 100nF         | 100nF          | 1206, X7R, +/-10%    |
| IC1  | TDA5220       | TDA5220        | Infineon             |
| L1   | 15nH          | 3.3nH          | Toko, PTL2012-F15N0G |
| L2   | 8.2pF         | 3.9pF          | 0805, COG, +/-0.1pF  |
| Q1   | 13.234375 MHz | 13.4015625 MHz | 1053-922             |
| Q2   | SFE_10.7MA5-A | SFE_10.7MA5-A  | Murata               |
| R1   | 100kΩ         | 100kΩ          | 0805, +/-5%          |
| R4   | 240kΩ         | 240kΩ          | 0805, +/-5%          |
| R5   | 360kΩ         | 360kΩ          | 0805, +/-5%          |

Table 11Bill of Materials (cont'd)



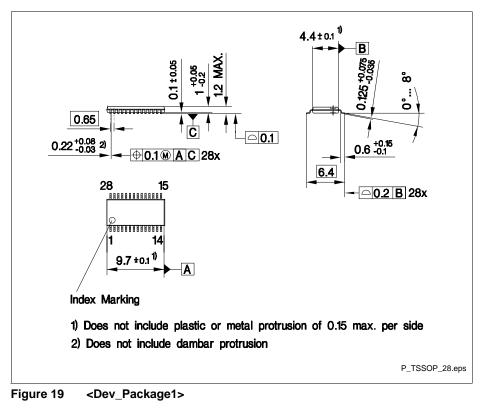
| Ref. | Value 434MHz                  | Value 868MHz                     | Specification                   |
|------|-------------------------------|----------------------------------|---------------------------------|
| R6   | 10kΩ                          | 10kΩ                             | 0805, +/-5%                     |
| S1   | STL_2POL                      | STL_2POL                         | 2-pole pin connector            |
| S2   | SOL_JUMP                      | SOL_JUMP                         | SOL_JUMP                        |
| S3   | SOL_JUMP                      | SOL_JUMP                         | SOL_JUMP                        |
| S6   | SOL_JUMP                      | SOL_JUMP                         | SOL_JUMP                        |
| X1   | STL_2POL                      | STL_2POL                         | 2-pole pin connector            |
| X2   | A107-900A (1.6mm gold plated) | A107-900A (1.6mm<br>gold plated) | INPUT OUTPUT<br>ENTERPRISE CORP |
| Х3   | A107-900A (1.6mm gold plated) | A107-900A (1.6mm gold plated)    | INPUT OUTPUT<br>ENTERPRISE CORP |

Please note that in case of operation at 434MHz a capacitor has to be soldered in place L2 and an inductor in place C6.



#### **Package Outlines**

# 5 Package Outlines



#### Table 12 Order Information

| Туре     | Ordering Code | Package                       |
|----------|---------------|-------------------------------|
| TDA 5220 | Q67100-H2049  | <dev_package1></dev_package1> |

You can find all of our packages, sorts of packing and others in our Infineon Internet Page "Products": http://www.infineon.com/products.

SMD = Surface Mounted Device

Dimensions in mm



# TDA 5220

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| nguie 19 1 - 10001 - 20-1 40 | Figure 17<br>Figure 18<br>Figure 19   | Component Placement on the Evaluation Board<br>P-TSSOP-28-1   | 45   |

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